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TITLE: Copper etching bath and method of using

DATE-ISSUED: January 1, 1991

INVENTOR-INFORMATION:

NAME CITY STATE ZIP CODE COUNTRY
Tytgat; Daniel Brussels N/A N/A BEX
Magnus; Stefaan Halle N/A N/A BEX

US-CL-CURRENT: <u>216/106</u>; <u>252/79.2</u>

ABSTRACT:

Baths for the chemical polishing of copper or copper alloy surfaces, comprising, in aqueous solution, hydrogen peroxide, chloride ions, phosphoric acid and phosphate and hydrogenphosphate ions, in quantities adjusted so as to impart a pH of between 1.25 and 3 to the bath.

7 Claims, 3 Drawing figures Exemplary Claim Number: 4 Number of Drawing Sheets: 2